

## SAM<sup>TM</sup> Data Sheet SAM-1100-90-500fs-x, $\lambda$ = 1100 nm

Laser wavelength  $\lambda = 1100 \text{ nm}$ 

High reflection band  $\lambda = 1040 ... 1150 \text{ nm}$ 

Absorptance  $A_0 = 90 \%$  Modulation depth  $\Delta R = 50 \%$  Non-saturable loss  $A_{ns} = 40 \%$ 

Saturation fluence  $\Phi_{\text{sat}} = 40 \,\mu\text{J/cm}^2$ 

Relaxation time constant  $\tau \sim 500 \text{ fs}$ 

Damage threshold  $\Phi = 400 \,\mu\text{J/cm}^2$ 

Chip area 4.0 mm x 4.0 mm; other dimensions on request

Chip thickness 450 µm

Protection the SAM is protected with a dielectric front layer

Mounting option  $\mathbf{x}$  denotes the type of mounting as follows:

x = 0 unmounted

 $x = 12.7 \, \mathrm{g}$ glued on a copper heat sink with 12.7 mm  $\varnothing$  $x = 25.4 \, \mathrm{g}$ glued on a copper heat sink with 25.4 mm  $\varnothing$  $x = 12.7 \, \mathrm{s}$ soldered on a copper heat sink with 12.7 mm  $\varnothing$  $x = 25.4 \, \mathrm{s}$ soldered on a copper heat sink with 25.4 mm  $\varnothing$ 

x = 25.0 w soldered water cooled copper heat sink with 25.0 mm Ø

x = FC/PC mounted on a 1 m monomode fiber cable with FC/PC connector

## Low intensity spectral reflectance

